



DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am an inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled: "METHOD AND APPARATUS FOR REPRESENTING AND ENCAPSULATING ACTIVE COMPUTING ENVIRONMENTS"

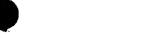
the specification of which (check one)

is attached hereto

(X)

()	and was amended on	zed person on my behalf on as Application No if applicable)	•
		d and understand the contents of mended by any amendment referred	
· ·	•	nformation which is material to the 7, Code of Federal Regulations, §1.56	
application(s) identified below me or m	for patent or inventor's ow any foreign application	s under Title 35, United States Code certificate listed below and so ident on for patent or inventor's certificate or assigns and having a filing dated.	tified, and I have also on this invention filed
可 [] [Number	<u>Country</u>	Day/Month/Year Filed	Priority Claimed (Yes or No)
	•		No

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:



Application Serial No.

Filing Date

Status

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint Coudert Brothers, a firm including J.D. Harriman, Reg. No. 31,967 and Micah Goldsmith, Reg. No. 43,638, and Sun Microsystems, Inc., a corporation, including Kenneth Olsen, Reg. No. 26,493, Timothy J. Crean, Reg. No. 37,116, Joseph T. FitzGerald, Reg. No. 33,881, Robert S. Hauser, Reg. No. 37,847, Alexander E. Silverman, Reg. No. 37,940, Anirma R. Gupta, Reg. No. 38,275, Sean P. Lewis, Reg. No. 42,798, Michael J. Schallop, Reg. No. 44,319, Bernice B. Chen, Reg. No. 42,403, Kenta Suzue, Reg. No. 45,145, Noreen A. Krall, Reg. No. 39,734, Richard J. Lutton, Jr., Reg. 39,756, Monica D. Ward, Reg. No. 40,696, Marc D. Foodman, Reg. No. 34,110, Naren Chaganti, Reg. No. 44,602. Elaine Lee, Reg. No. 41,936, Hugh H. Matsubayashi, Reg. No. 43,779, and Paul D. Sorken, Reg. No. 39,039 with full power of substitution and revocation, to prosecute this application and to transact all business in the substitution and telephone calls in respect to this application be directed to COUDERT BROTHERS, 333 South Hope Street, Suite 2300, Los Angeles, California 90071, Telephone No. (213) 229-2900, Customer No. 23600.

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Thventor's signature:	Buan K Schnick
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